

# EC2645ETTS-7.875M

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## REGULATORY COMPLIANCE (Data Sheet downloaded on Oct 23, 2016)


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## ITEM DESCRIPTION

Quartz Crystal Clock Oscillators XO (SPXO) LVCMOS (CMOS) 3.3Vdc 4 Pad 5.0mm x 7.0mm Ceramic Surface Mount (SMD) 7.875MHz  $\pm 50$ ppm -40°C to +85°C

## ELECTRICAL SPECIFICATIONS

|                                               |                                                                                                                                                                                                                                        |
|-----------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Nominal Frequency                             | 7.875MHz                                                                                                                                                                                                                               |
| Frequency Tolerance/Stability                 | $\pm 50$ ppm Maximum (Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, First Year Aging at 25°C, Shock, and Vibration) |
| Aging at 25°C                                 | $\pm 5$ ppm/year Maximum                                                                                                                                                                                                               |
| Operating Temperature Range                   | -40°C to +85°C                                                                                                                                                                                                                         |
| Supply Voltage                                | 3.3Vdc $\pm 10\%$                                                                                                                                                                                                                      |
| Input Current                                 | 10mA Maximum                                                                                                                                                                                                                           |
| Output Voltage Logic High (Voh)               | 90% of Vdd Minimum (IOH=-8mA)                                                                                                                                                                                                          |
| Output Voltage Logic Low (Vol)                | 10% of Vdd Maximum (IOL=+8mA)                                                                                                                                                                                                          |
| Rise/Fall Time                                | 5nSec Maximum (w/15pF Load), 7nSec Maximum (w/30pF Load) (Measured at 20% to 80% of waveform)                                                                                                                                          |
| Duty Cycle                                    | 50 $\pm 10$ (%) (Measured at 50% of waveform)                                                                                                                                                                                          |
| Load Drive Capability                         | 30pF Maximum                                                                                                                                                                                                                           |
| Output Logic Type                             | CMOS                                                                                                                                                                                                                                   |
| Pin 1 Connection                              | Tri-State (High Impedance)                                                                                                                                                                                                             |
| Output Control Input Voltage Logic High (Vih) | 70% of Vdd Minimum or No Connect to Enable Output                                                                                                                                                                                      |
| Output Control Input Voltage Logic Low (Vil)  | 30% of Vdd Maximum to Disable Output (High Impedance)                                                                                                                                                                                  |
| Standby Current                               | 10 $\mu$ A Maximum (Disabled Output: High Impedance)                                                                                                                                                                                   |
| RMS Phase Jitter                              | 1pSec Maximum (12kHz to 20MHz offset frequency)                                                                                                                                                                                        |
| Start Up Time                                 | 10mSec Maximum                                                                                                                                                                                                                         |
| Storage Temperature Range                     | -55°C to +125°C                                                                                                                                                                                                                        |

## ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

|                              |                                               |
|------------------------------|-----------------------------------------------|
| ESD Susceptibility           | MIL-STD-883, Method 3015, Class 1, HBM: 1500V |
| Fine Leak Test               | MIL-STD-883, Method 1014, Condition A         |
| Flammability                 | UL94-V0                                       |
| Gross Leak Test              | MIL-STD-883, Method 1014, Condition C         |
| Mechanical Shock             | MIL-STD-883, Method 2002, Condition B         |
| Moisture Resistance          | MIL-STD-883, Method 1004                      |
| Moisture Sensitivity         | J-STD-020, MSL 1                              |
| Resistance to Soldering Heat | MIL-STD-202, Method 210, Condition K          |
| Resistance to Solvents       | MIL-STD-202, Method 215                       |
| Solderability                | MIL-STD-883, Method 2003                      |
| Temperature Cycling          | MIL-STD-883, Method 1010, Condition B         |
| Vibration                    | MIL-STD-883, Method 2007, Condition A         |

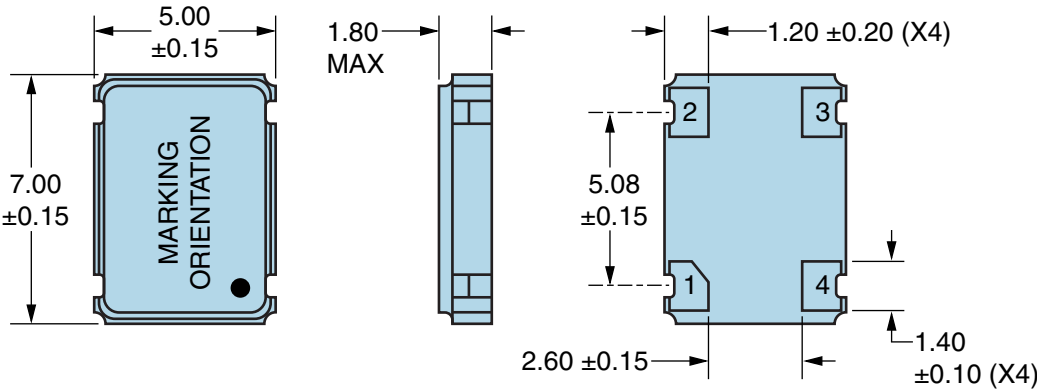
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MECHANICAL DIMENSIONS (all dimensions in millimeters)

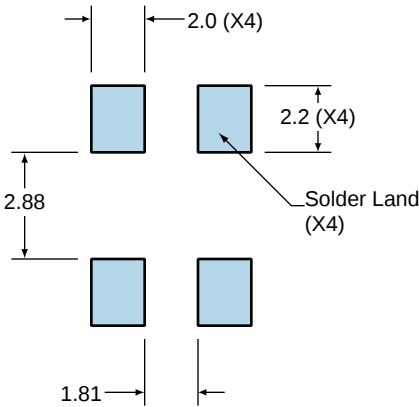
| PIN | CONNECTION     |
|-----|----------------|
| 1   | Tri-State      |
| 2   | Case/Ground    |
| 3   | Output         |
| 4   | Supply Voltage |

| LINE | MARKING                                               |
|------|-------------------------------------------------------|
| 1    | ECLIPTEK                                              |
| 2    | 7.8750M                                               |
| 3    | XXXXXX<br>XXXXXX=Ecliptek<br>Manufacturing Identifier |



Suggested Solder Pad Layout

All Dimensions in Millimeters



All Tolerances are ±0.1

OUTPUT WAVEFORM & TIMING DIAGRAM



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**Test Circuit for CMOS Output**

Note 1: An external  $0.1\mu\text{F}$  low frequency tantalum bypass capacitor in parallel with a  $0.01\mu\text{F}$  high frequency ceramic bypass capacitor close to the package ground and  $V_{DD}$  pin is required.

Note 2: A low capacitance ( $<12\text{pF}$ ), 10X attenuation factor, high impedance ( $>10\text{Mohms}$ ), and high bandwidth ( $>300\text{MHz}$ ) passive probe is recommended.

Note 3: Capacitance value  $C_L$  includes sum of all probe and fixture capacitance.

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Recommended Solder Reflow Methods



High Temperature Infrared/Convection

|                                     |                                                   |
|-------------------------------------|---------------------------------------------------|
| Ts MAX to Tl (Ramp-up Rate)         | 3°C/Second Maximum                                |
| Preheat                             |                                                   |
| - Temperature Minimum (Ts MIN)      | 150°C                                             |
| - Temperature Typical (Ts TYP)      | 175°C                                             |
| - Temperature Maximum (Ts MAX)      | 200°C                                             |
| - Time (ts MIN)                     | 60 - 180 Seconds                                  |
| Ramp-up Rate (Tl to Tp)             | 3°C/Second Maximum                                |
| Time Maintained Above:              |                                                   |
| - Temperature (Tl)                  | 217°C                                             |
| - Time (tL)                         | 60 - 150 Seconds                                  |
| Peak Temperature (Tp)               | 260°C Maximum for 10 Seconds Maximum              |
| Target Peak Temperature (Tp Target) | 250°C +0/-5°C                                     |
| Time within 5°C of actual peak (tp) | 20 - 40 Seconds                                   |
| Ramp-down Rate                      | 6°C/Second Maximum                                |
| Time 25°C to Peak Temperature (t)   | 8 Minutes Maximum                                 |
| Moisture Sensitivity Level          | Level 1                                           |
| Additional Notes                    | Temperatures shown are applied to body of device. |

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**Recommended Solder Reflow Methods****Low Temperature Infrared/Convection 240°C**

|                             |                    |
|-----------------------------|--------------------|
| TS MAX to TL (Ramp-up Rate) | 5°C/Second Maximum |
|-----------------------------|--------------------|

**Preheat**

|                                |                  |
|--------------------------------|------------------|
| - Temperature Minimum (TS MIN) | N/A              |
| - Temperature Typical (TS TYP) | 150°C            |
| - Temperature Maximum (TS MAX) | N/A              |
| - Time (ts MIN)                | 60 - 120 Seconds |

|                         |                    |
|-------------------------|--------------------|
| Ramp-up Rate (TL to TP) | 5°C/Second Maximum |
|-------------------------|--------------------|

**Time Maintained Above:**

|                    |                     |
|--------------------|---------------------|
| - Temperature (TL) | 150°C               |
| - Time (tL)        | 200 Seconds Maximum |

|                       |               |
|-----------------------|---------------|
| Peak Temperature (TP) | 240°C Maximum |
|-----------------------|---------------|

|                                     |                                              |
|-------------------------------------|----------------------------------------------|
| Target Peak Temperature (TP Target) | 240°C Maximum 2 Times / 230°C Maximum 1 Time |
|-------------------------------------|----------------------------------------------|

|                                     |                                                        |
|-------------------------------------|--------------------------------------------------------|
| Time within 5°C of actual peak (tp) | 10 Seconds Maximum 2 Times / 80 Seconds Maximum 1 Time |
|-------------------------------------|--------------------------------------------------------|

|                |                    |
|----------------|--------------------|
| Ramp-down Rate | 5°C/Second Maximum |
|----------------|--------------------|

|                                   |     |
|-----------------------------------|-----|
| Time 25°C to Peak Temperature (t) | N/A |
|-----------------------------------|-----|

|                            |         |
|----------------------------|---------|
| Moisture Sensitivity Level | Level 1 |
|----------------------------|---------|

|                  |                                                   |
|------------------|---------------------------------------------------|
| Additional Notes | Temperatures shown are applied to body of device. |
|------------------|---------------------------------------------------|

**Low Temperature Manual Soldering**

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)

**High Temperature Manual Soldering**

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)